

## 1A, 30V - 60V Schottky Barrier Surface Mount Rectifier

### FEATURES

- Very low profile - typical height of 0.68mm
- Low power loss, high efficiency
- Ideal for automated placement
- Moisture sensitivity level: level 1, per J-STD-020
- RoHS Compliant
- Halogen-free according to IEC 61249-2-21

### APPLICATIONS

- Switching mode power supply (SMPS)
- Adapters
- DC to DC converter

### MECHANICAL DATA

- Case: Micro SMA
- Molding compound meets UL 94V-0 flammability rating
- Terminal: Matte tin plated leads, solderable per J-STD-002
- Meet JESD 201 class 2 whisker test
- Polarity: Indicated by cathode band
- Weight: 0.006g (approximately)

KEY PARAMETERS		
PARAMETER	VALUE	UNIT
$I_F$	1	A
$V_{RRM}$	30 - 60	V
$I_{FSM}$	25	A
$T_{JMAX}$	150	°C
Package	Micro SMA	
Configuration	Single die	



Micro SMA



ABSOLUTE MAXIMUM RATINGS ( $T_A = 25^\circ\text{C}$ unless otherwise noted)					
PARAMETER	SYMBOL	SS13M	SS14M	SS16M	UNIT
Marking code on the device		A	B	C	
Repetitive peak reverse voltage	$V_{RRM}$	30	40	60	V
Reverse voltage, total rms value	$V_{R(RMS)}$	21	28	42	V
Forward current	$I_F$	1			A
Surge peak forward current, 8.3ms single half sine wave superimposed on rated load	$I_{FSM}$	25			A
Junction temperature	$T_J$	-55 to +150			°C
Storage temperature	$T_{STG}$	-55 to +150			°C

<b>THERMAL PERFORMANCE</b>			
<b>PARAMETER</b>	<b>SYMBOL</b>	<b>TYP</b>	<b>UNIT</b>
Junction-to-lead thermal resistance	$R_{\theta JL}$	30	$^{\circ}C/W$
Junction-to-ambient thermal resistance	$R_{\theta JA}$	125	$^{\circ}C/W$
Junction-to-case thermal resistance	$R_{\theta JC}$	40	$^{\circ}C/W$

<b>ELECTRICAL SPECIFICATIONS</b> ( $T_A = 25^{\circ}C$ unless otherwise noted)							
<b>PARAMETER</b>		<b>CONDITIONS</b>	<b>SYMBOL</b>	<b>TYP</b>	<b>MAX</b>	<b>UNIT</b>	
Forward voltage <sup>(1)</sup>	SS13M	$I_F = 0.5A, T_J = 25^{\circ}C$	$V_F$	0.45	-	V	
		$I_F = 1.0A, T_J = 25^{\circ}C$		0.52	0.55	V	
	SS14M	$I_F = 0.5A, T_J = 125^{\circ}C$		0.35	-	V	
		$I_F = 1.0A, T_J = 125^{\circ}C$		0.46	0.50	V	
	SS16M	$I_F = 0.5A, T_J = 25^{\circ}C$	$V_F$	0.51	-	V	
		$I_F = 1.0A, T_J = 25^{\circ}C$		0.64	0.68	V	
		$I_F = 0.5A, T_J = 125^{\circ}C$		0.46	-	V	
		$I_F = 1.0A, T_J = 125^{\circ}C$		0.57	0.60	V	
Reverse current @ rated $V_R$ <sup>(2)</sup>		$T_J = 25^{\circ}C$	$I_R$	-	50	$\mu A$	
		$T_J = 125^{\circ}C$		-	10	mA	
Junction capacitance		1MHz, $V_R = 4.0V$	$C_J$	50	-	pF	
				SS13M	40	-	pF
				SS14M			
		SS16M					

**Notes:**

1. Pulse test with  $PW = 0.3ms$
2. Pulse test with  $PW = 30ms$

<b>ORDERING INFORMATION</b>		
<b>ORDERING CODE<sup>(1)</sup></b>	<b>PACKAGE</b>	<b>PACKING</b>
SS1xM	Micro SMA	12,000 / Tape & Reel

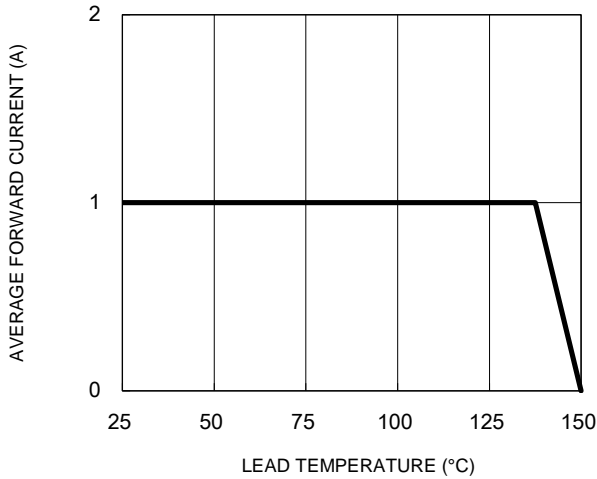
**Notes:**

1. "x" defines voltage from 30V(SS13M) to 60V(SS16M)

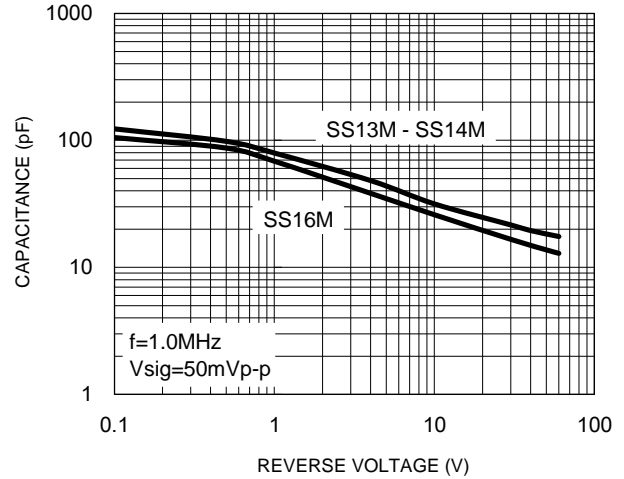
**CHARACTERISTICS CURVES**

( $T_A = 25^\circ\text{C}$  unless otherwise noted)

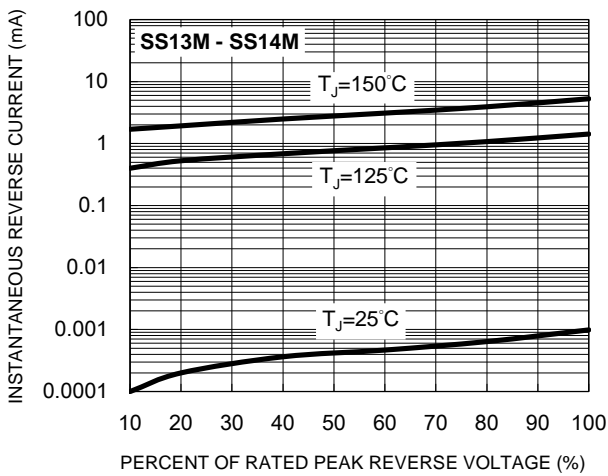
**Fig.1 Forward Current Derating Curve**



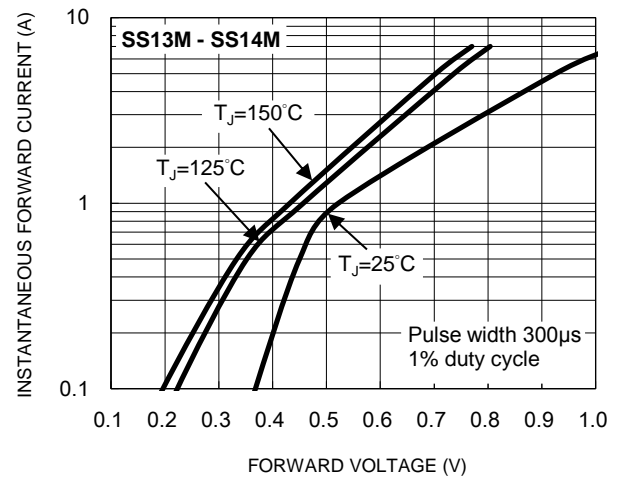
**Fig.2 Typical Junction Capacitance**



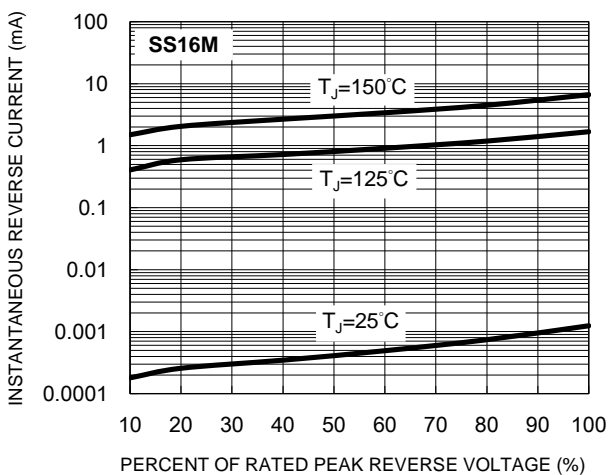
**Fig.3 Typical Reverse Characteristics**



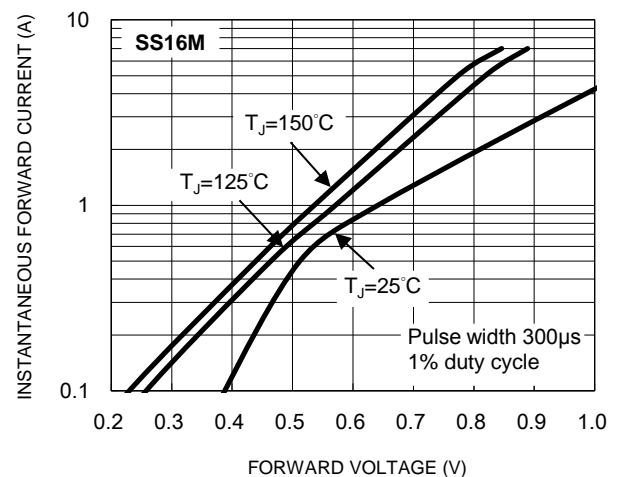
**Fig.4 Typical Forward Characteristics**



**Fig.5 Typical Reverse Characteristics**



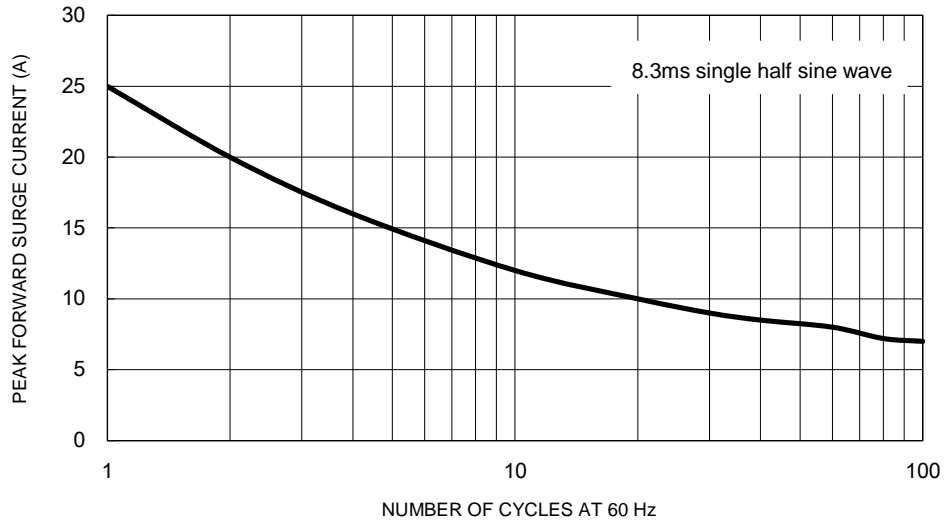
**Fig.6 Typical Forward Characteristics**



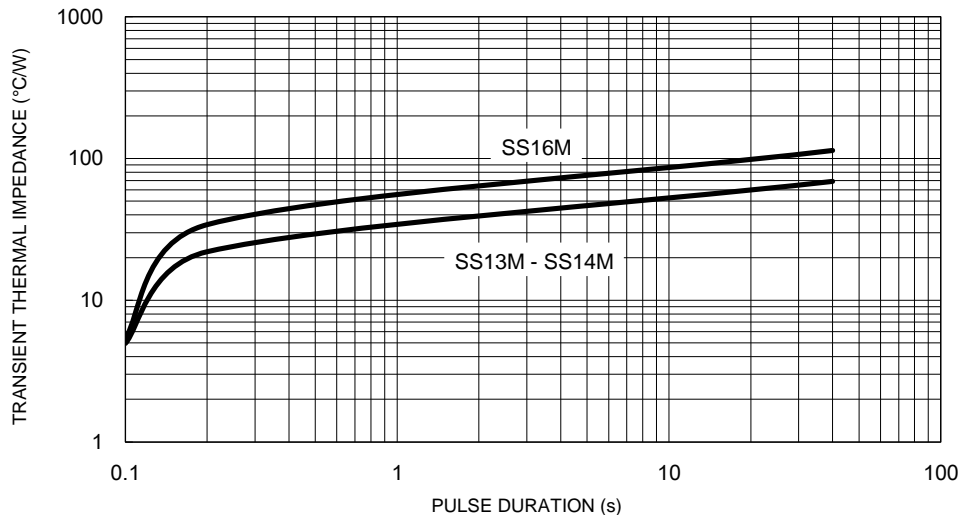
**CHARACTERISTICS CURVES**

( $T_A = 25^\circ\text{C}$  unless otherwise noted)

**Fig.7 Maximum Non-Repetitive Forward Surge Current**

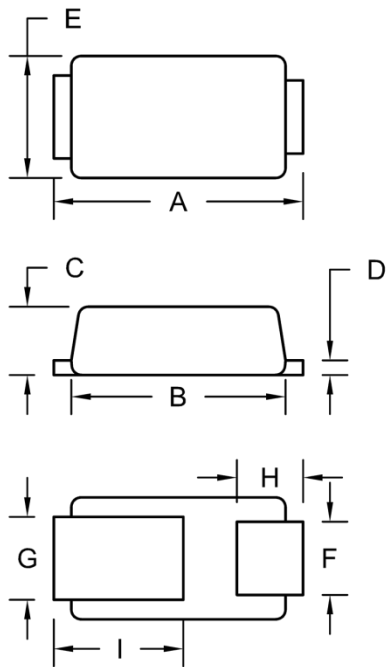


**Fig.8 Typical Transient Thermal Impedance**



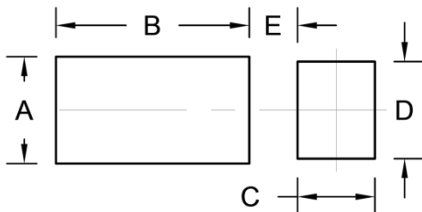
**PACKAGE OUTLINE DIMENSIONS**

Micro SMA



DIM.	Unit (mm)		Unit (inch)	
	Min.	Max.	Min.	Max.
A	2.30	2.70	0.091	0.106
B	2.10	2.30	0.083	0.091
C	0.63	0.73	0.025	0.029
D	0.10	0.20	0.004	0.008
E	1.15	1.35	0.045	0.053
F	0.65	0.85	0.026	0.034
G	0.75	0.95	0.030	0.037
H	0.55	0.75	0.022	0.030
I	1.10	1.50	0.043	0.059

**SUGGESTED PAD LAYOUT**



Symbol	Unit (mm)	Unit (inch)
A	1.10	0.043
B	2.00	0.079
C	0.80	0.031
D	1.00	0.039
E	0.50	0.020

**MARKING DIAGRAM**



P/N = Marking Code  
YW = Data Code

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